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XA-9613  
PATENT APPLICATION

Response Under 37 C.F.R. § 1.116  
Expedited Procedure  
Examining Group 3729

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Toshihiko TANAKA et al.

Appln. No.: 10/045,036

Group Art Unit: 3729

Filed: January 15, 2002

Examiner: T. PHAN

For: Wiring Substrate Manufacturing Method

AMENDMENT AFTER FINAL OFFICE ACTION

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

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JUL 23 2004

TECHNOLOGY CENTER 20700

Sir:

In response to the Office Action mailed on March 18, 2004, please amend the above-identified patent application as indicated below.

Amendments to the Claims, reflected in the Listing of Claims, begin on page 2 of this paper.

Remarks begin on page 5 of this paper.